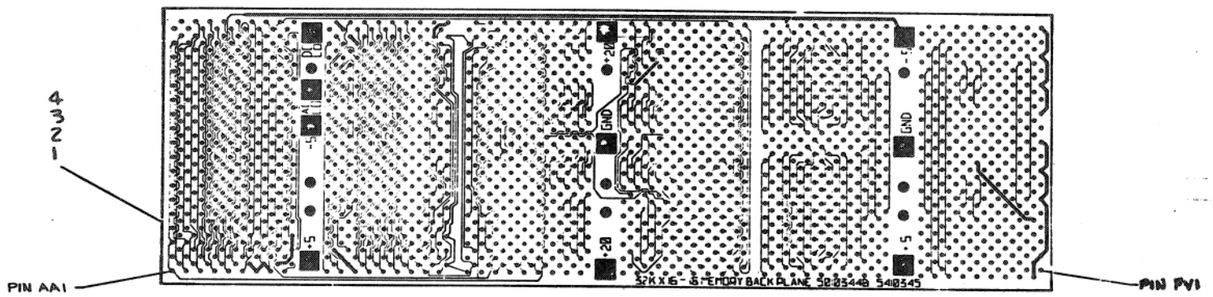
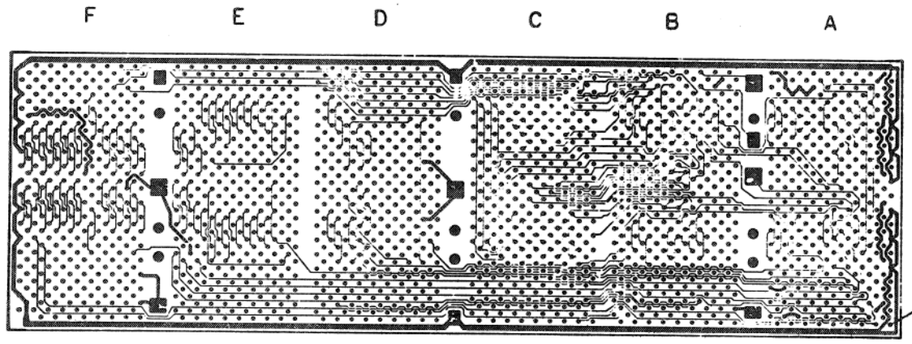
This drawing and specifications, herein, are the property of Digital Equipment Corporation and shall not be reproduced or copied or used in whole or in part as the basis for the manufacture or sale of items without written permission.
COPYRIGHT © 1973
DIGITAL EQUIPMENT CORP.

NOTES:
1. THIS IS A MULTILAYER BOARD
2. +5V PINS AA2, BA2, CA2, DA2, EA2, FA2 ARE CONNECTED TOGETHER THROUGH LAYER 3.
3. GND PINS AC2, AT1, BC2, BT1, CC2, CT1, DC2, DT1 EC2, ET1, FC2, FT1 ARE CONNECTED TOGETHER THROUGH LAYER 2



SOLDER SIDE



CONN BLOCK SIDE

IC TYPE	GND	+ 5V
GND AND 5V ARE USUALLY PIN 7 AND 14 RESPECTIVELY EXCEPTIONS ARE STATED ABOVE		

IC PIN LOCATIONS

QTY	REF DESIGNATION	DESCRIPTION	PART NO.	ITEM NO.
1		ETCHED CIRCUIT BOARD	5010344	4
REF		MODULE ECO HISTORY	B-VM-5410345-01	3
REF		ASSY/DRILLING HOLE LAYOUT	D-AD-5410345-0-1	2
REF		X-Y COORDINATE HOLE LOCATION	XCO-5410345-0-1	1

PARTS LIST

FIRST USED ON OPTION MODEL: MMII-U
ETCH BOARD REV: B

DEC NO.	EIA NO.	DEC NO.	EIA NO.

SEMICONDUCTOR CONVERSION CHART

REV	CHANGE NO.	CHK	DRN	CHK'D	ENG	MANU. ENG.	PROD.	DATE
A	5413345-00001	HS	P. DURANT	H.S.				8-19-71

NEXT HIGHER ASSY: D-AD-7103295-0-0
SCALE: —
SHEET 1 OF 1

digital EQUIPMENT CORPORATION MAYNARD MASSACHUSETTS

TITLE: 32K X 16-18 MEMORY BACK PLANE

SIZE: D | CODE: DCS | NUMBER: 5410345-0-1 | REV: B

DIST